



Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	16
Program Memory Size	4KB (4K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323les2004g



Table of Contents

Development Features	1
General Description	2
Pin Description	4
Absolute Maximum Ratings	10
Standard Test Conditions	10
DC Characteristics	11
AC Characteristics	14
Pin Functions	16
XTAL1 Crystal 1 (Time-Based Input)	16
XTAL2 Crystal 2 (Time-Based Output)	16
Port 0 (P07–P00)	16
Port 1 (P17–P10)	17
Port 2 (P27–P20)	18
Port 3 (P37–P30)	19
RESET (Input, Active Low)	23
Functional Description	23
Program Memory	23
RAM	23
Expanded Register File	24
Register File	28
Stack	29
Timers	30
Counter/Timer Functional Blocks	38
Expanded Register File Control Registers (0D)	64
Expanded Register File Control Registers (0F)	69
Standard Control Registers	73
Package Information	80
Ordering Information	89
Precharacterization Product	95



Figure 35. Stop Mode Recovery Source	57
Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only) . . .	59
Figure 37. Watch-Dog Timer Mode Register (Write Only)	60
Figure 38. Resets and WDT	61
Figure 39. TC8 Control Register ((0D)00H: Read/Write Except Where Noted) . . .	64
Figure 40. T8 and T16 Common Control Functions ((0D)01H: Read/Write) . . .	65
Figure 41. T16 Control Register ((0D) 2H: Read/Write Except Where Noted) . . .	67
Figure 42. T8/T16 Control Register (0D)03H: Read/Write (Except Where Noted)	68
Figure 43. Voltage Detection Register	69
Figure 44. Port Configuration Register (PCON)(0F)00H: Write Only)	70
Figure 45. Stop Mode Recovery Register ((0F)0BH: D6–D0=Write Only, D7=Read Only)	71
Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only) . . .	72
Figure 47. Watch-Dog Timer Register ((0F) 0FH: Write Only)	73
Figure 48. Port 2 Mode Register (F6H: Write Only)	73
Figure 49. Port 3 Mode Register (F7H: Write Only)	74
Figure 50. Port 0 and 1 Mode Register (F8H: Write Only)	75
Figure 51. Interrupt Priority Register (F9H: Write Only)	76
Figure 52. Interrupt Request Register (FAH: Read/Write)	77
Figure 53. Interrupt Mask Register (FBH: Read/Write)	77
Figure 54. Flag Register (FCH: Read/Write)	78
Figure 55. Register Pointer (FDH: Read/Write)	78
Figure 56. Stack Pointer High (FEH: Read/Write)	79
Figure 57. Stack Pointer Low (FFH: Read/Write)	79
Figure 58. 20-Pin CDIP Package	80
Figure 59. 20-Pin PDIP Package Diagram	81
Figure 60. 20-Pin SOIC Package Diagram	81
Figure 61. 20-Pin SSOP Package Diagram	82
Figure 62. 28-Pin CDIP Package	83
Figure 63. 28-Pin SOIC Package Diagram	84
Figure 64. 28-Pin PDIP Package Diagram	85
Figure 65. 28-Pin SSOP Package Diagram	86
Figure 66. 40-Pin CDIP Package	87
Figure 67. 40-Pin PDIP Package Diagram	87
Figure 68. 48-Pin SSOP Package Design	88

Table 8. DC Characteristics (Continued)

Symbol	Parameter	V _{CC}	T _A = 0°C to +70°C			Units	Conditions	Notes
			Min	Typ	Max			
I _{CC1}	Standby Current (HALT Mode)	2.0			3	mA	V _{IN} = 0V, V _{CC} at 8.0MHz	1, 2
		3.6			5		Same as above	1, 2
		2.0			2		Clock Divide-by-16 at 8.0MHz	1, 2
		3.6			4		Same as above	1, 2
I _{CC2}	Standby Current (Stop Mode)	2.0			8	μA	V _{IN} = 0 V, V _{CC} WDT is not Running	3
		3.6			10	μA	Same as above	3
		2.0			500	μA	V _{IN} = 0 V, V _{CC} WDT is Running	3
		3.6			800	μA	Same as above	3
I _{LV}	Standby Current (Low Voltage)				10	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection				2.0	V	8MHz maximum Ext. CLK Freq.	
V _{LVD}	V _{CC} Low Voltage Detection			2.4		V		
V _{HVD}	V _{CC} High Voltage Detection			2.7		V		

Notes:

1. All outputs unloaded, inputs at rail.
2. CL1 = CL2 = 100 pF.
3. Oscillator stopped.
4. Oscillator stops when V_{CC} falls below V_{BO} limit.
5. It is strongly recommended to add a filter capacitor (minimum 0.1 μF), physically close to the V_{DD} and V_{SS} pins if operating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.

Pin Functions

XTAL1 Crystal 1 (Time-Based Input)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator input. Additionally, an optional external single-phase clock can be coded to the on-chip oscillator input.

XTAL2 Crystal 2 (Time-Based Output)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator output.

Port 0 (P07–P00)

Port 0 is an 8-bit, bidirectional, CMOS-compatible port. These eight I/O lines are configured under software control as a nibble I/O port. The output drivers are push-pull or open-drain controlled by bit D2 in the PCON register.

If one or both nibbles are needed for I/O operation, they must be configured by writing to the Port 0 mode register. After a hardware reset, Port 0 is configured as an input port.

An optional pull-up transistor is available as a mask option on all Port 0 bits with nibble select.

- **Notes:** Internal pull-ups are disabled on any given pin or group of port pins when programmed into output mode.

The Port 0 direction is reset to be input following an SMR.

Capture_INT_Mask

Set this bit to allow an interrupt when data is captured into either LO8 or HI8 upon a positive or negative edge detection in demodulation mode.

Counter_INT_Mask

Set this bit to allow an interrupt when T8 has a timeout.

P34_Out

This bit defines whether P34 is used as a normal output pin or the T8 output.

T8 and T16 Common Functions—CTR1(0D)01H

This register controls the functions in common with the T8 and T16.

Table 13 lists and briefly describes the fields for this register.

Table 13. CTR1(0D)01H T8 and T16 Common Functions

Field	Bit Position		Value	Description
Mode	7-----	R/W	0*	Transmit Mode Demodulation Mode
P36_Out/ Demodulator_Input	-6-----	R/W	0* 1 0 1	Transmit Mode Port Output T8/T16 Output Demodulation Mode P31 P20
T8/T16_Logic/ Edge_Detect	--54----	R/W	00** 01 10 11 00** 01 10 11	Transmit Mode AND OR NOR NAND Demodulation Mode Falling Edge Rising Edge Both Edges Reserved

into LO8; if it is a negative edge, data is put into HI8. From that point, one of the edge detect status bits (CTR1, D1; D0) is set, and an interrupt can be generated if enabled (CTR0, D2). Meanwhile, T8 is loaded with FFh and starts counting again. If T8 reaches 0, the timeout status bit (CTR0, D5) is set, and an interrupt can be generated if enabled (CTR0, D1). T8 then continues counting from FFh (see Figure 23 and Figure 24).

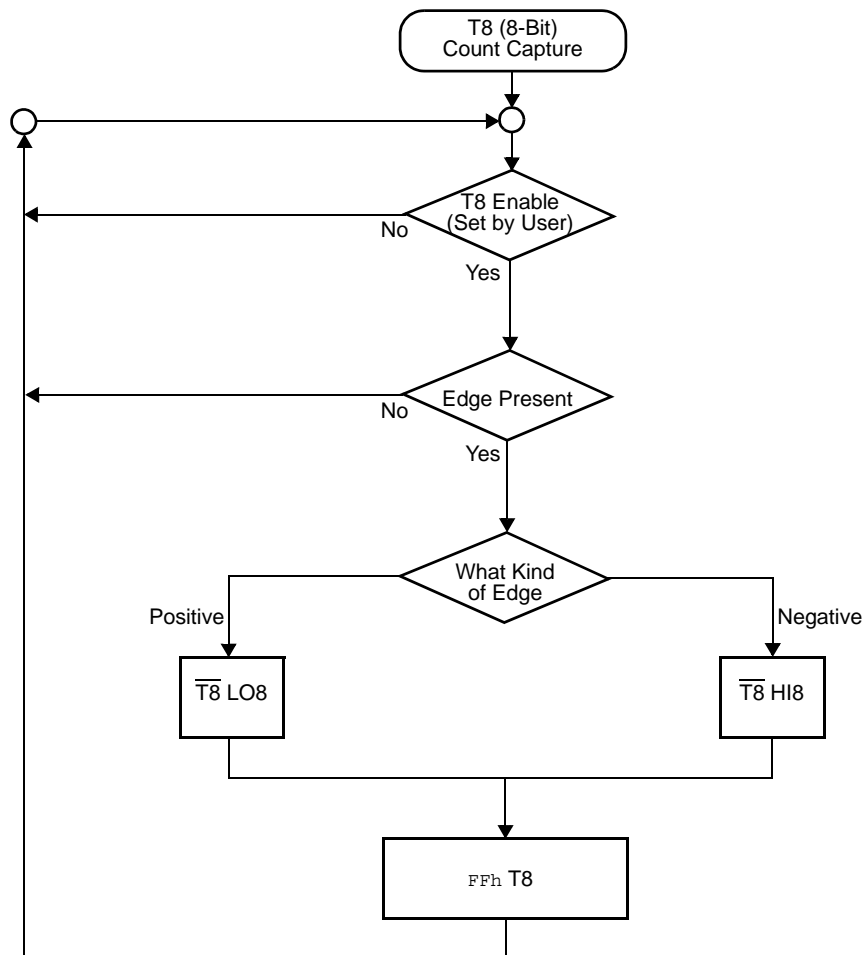


Figure 23. Demodulation Mode Count Capture Flowchart

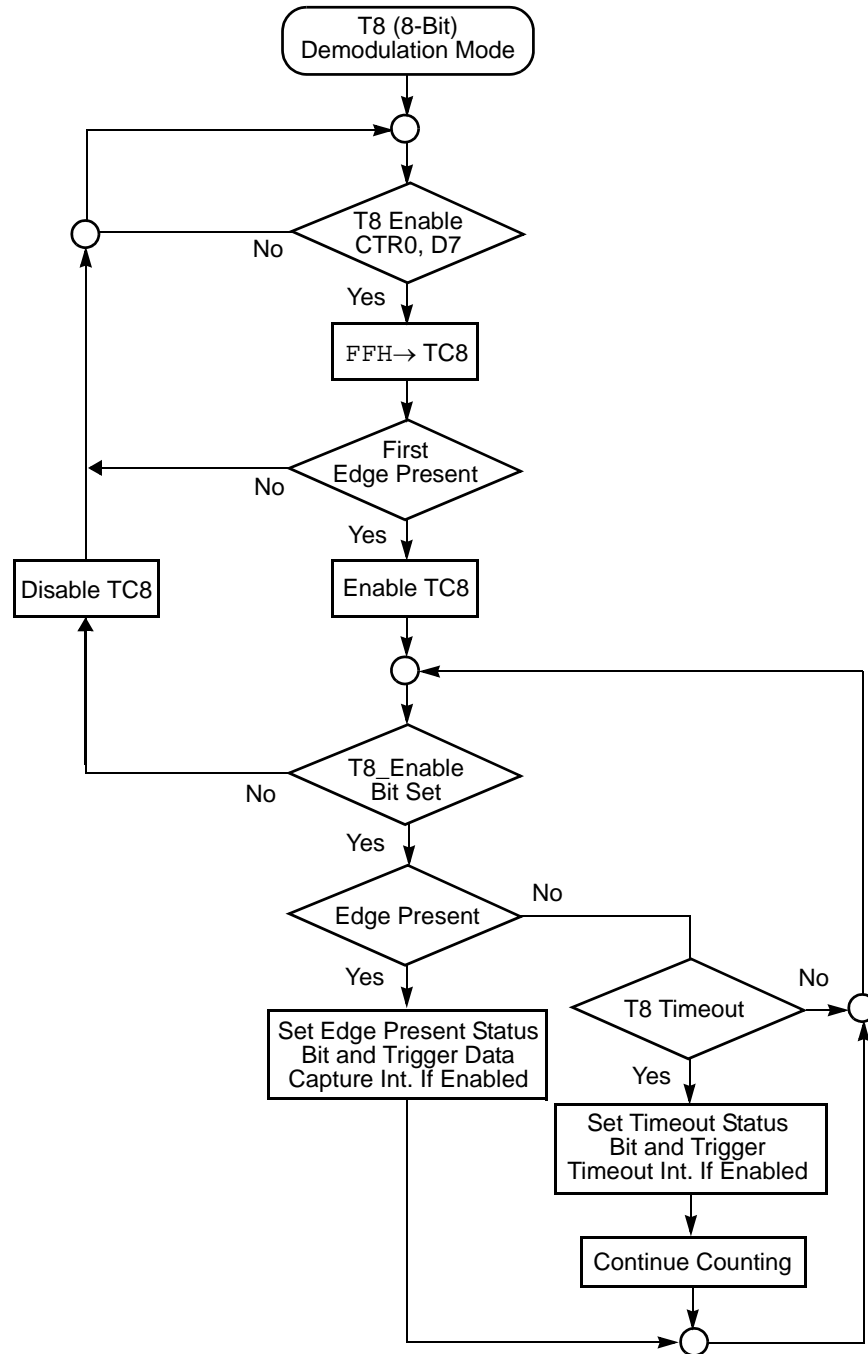


Figure 24. Demodulation Mode Flowchart



Caution:

Do not load these registers at the time the values are to be loaded into the counter/timer to ensure known operation. An initial count of 1 is not allowed. An initial count of 0 causes T16 to count from 0 to FFFFH to FFFE_H. Transition from 0 to FFFF_H is not a timeout condition.

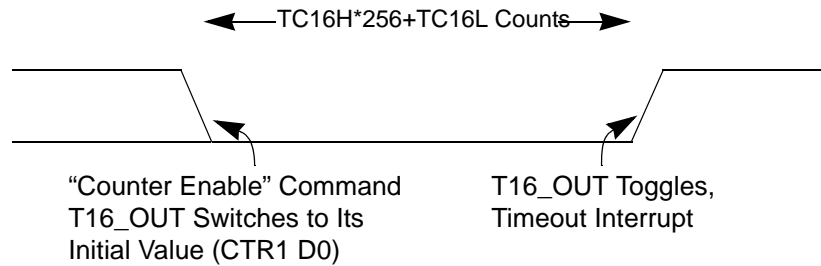


Figure 26. T16_OUT in Single-Pass Mode

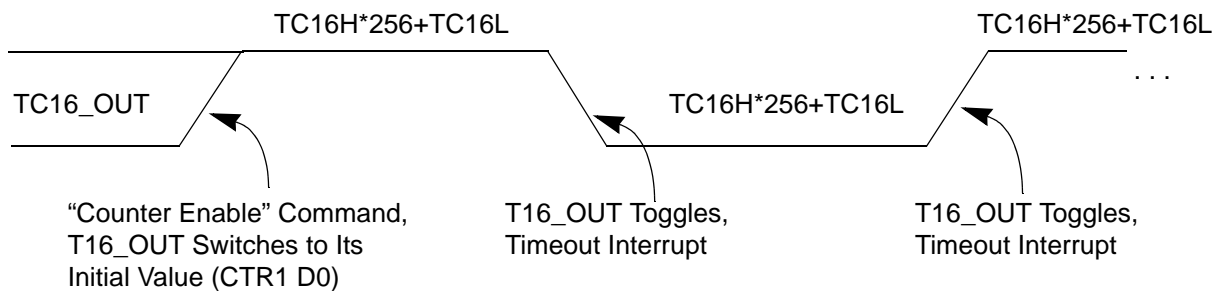


Figure 27. T16_OUT in Modulo-N Mode

T16 DEMODULATION Mode

The user must program TC16L and TC16H to FF_H. After T16 is enabled, and the first edge (rising, falling, or both depending on CTR1 D5; D4) is detected, T16 captures HI16 and LO16, reloads, and begins counting.

If D6 of CTR2 Is 0

When a subsequent edge (rising, falling, or both depending on CTR1, D5; D4) is detected during counting, the current count in T16 is complemented and put into HI16 and LO16. When data is captured, one of the edge detect status bits (CTR1, D1; D0) is set, and an interrupt is generated if enabled (CTR2, D2). T16 is loaded with FFFF_H and starts again.

This T16 mode is generally used to measure space time, the length of time between bursts of carrier signal (marks).

If D6 of CTR2 Is 1

T16 ignores the subsequent edges in the input signal and continues counting down. A timeout of T8 causes T16 to capture its current value and generate an interrupt if enabled (CTR2, D2). In this case, T16 does not reload and continues counting. If the D6 bit of CTR2 is toggled (by writing a 0 then a 1 to it), T16 captures and reloads on the next edge (rising, falling, or both depending on CTR1, D5; D4), continuing to ignore subsequent edges.

This T16 mode generally measures mark time, the length of an active carrier signal burst.

If T16 reaches 0, T16 continues counting from `FFFFh`. Meanwhile, a status bit (CTR2 D5) is set, and an interrupt timeout can be generated if enabled (CTR2 D1).

Ping-Pong Mode

This operation mode is only valid in TRANSMIT Mode. T8 and T16 must be programmed in Single-Pass mode (CTR0, D6; CTR2, D6), and Ping-Pong mode must be programmed in CTR1, D3; D2. The user can begin the operation by enabling either T8 or T16 (CTR0, D7 or CTR2, D7). For example, if T8 is enabled, T8_OUT is set to this initial value (CTR1, D1). According to T8_OUT's level, TC8H or TC8L is loaded into T8. After the terminal count is reached, T8 is disabled, and T16 is enabled. T16_OUT then switches to its initial value (CTR1, D0), data from TC16H and TC16L is loaded, and T16 starts to count. After T16 reaches the terminal count, it stops, T8 is enabled again, repeating the entire cycle. Interrupts can be allowed when T8 or T16 reaches terminal control (CTR0, D1; CTR2, D1). To stop the ping-pong operation, write 00 to bits D3 and D2 of CTR1. See Figure 28.

- **Note:** Enabling ping-pong operation while the counter/timers are running might cause intermittent counter/timer function. Disable the counter/timers and reset the status flags before instituting this operation.

Table 16. Interrupt Types, Sources, and Vectors

Name	Source	Vector Location	Comments
IRQ0	P32	0,1	External (P32), Rising, Falling Edge Triggered
IRQ1	P33	2,3	External (P33), Falling Edge Triggered
IRQ2	P31, T _{IN}	4,5	External (P31), Rising, Falling Edge Triggered
IRQ3	T16	6,7	Internal
IRQ4	T8	8,9	Internal
IRQ5	LVD	10,11	Internal

When more than one interrupt is pending, priorities are resolved by a programmable priority encoder controlled by the Interrupt Priority Register. An interrupt machine cycle activates when an interrupt request is granted. As a result, all subsequent interrupts are disabled, and the Program Counter and Status Flags are saved. The cycle then branches to the program memory vector location reserved for that interrupt. All Z8 GP™ OTP MCU Family interrupts are vectored through locations in the program memory. This memory location and the next byte contain the 16-bit address of the interrupt service routine for that particular interrupt request. To accommodate polled interrupt systems, interrupt inputs are masked, and the Interrupt Request register is polled to determine which of the interrupt requests require service.

An interrupt resulting from AN1 is mapped into IRQ2, and an interrupt from AN2 is mapped into IRQ0. Interrupts IRQ2 and IRQ0 can be rising, falling, or both edge triggered. These interrupts are programmable by the user. The software can poll to identify the state of the pin.

Programming bits for the Interrupt Edge Select are located in the IRQ Register (R250), bits D7 and D6. The configuration is indicated in Table 17.

Table 17. IRQ Register

IRQ		Interrupt Edge	
D7	D6	IRQ2 (P31)	IRQ0 (P32)
0	0	F	F
0	1	F	R
1	0	R	F
1	1	R/F	R/F

Note: F = Falling Edge; R = Rising Edge

Clock

The device's on-chip oscillator has a high-gain, parallel-resonant amplifier, for connection to a crystal, ceramic resonator, or any suitable external clock source (XTAL1 = Input, XTAL2 = Output). The crystal must be AT cut, 1 MHz to 8 MHz maximum, with a series resistance (RS) less than or equal to 100 Ω . The on-chip oscillator can be driven with a suitable external clock source.

The crystal must be connected across XTAL1 and XTAL2 using the recommended capacitors (capacitance greater than or equal to 22 pF) from each pin to ground.

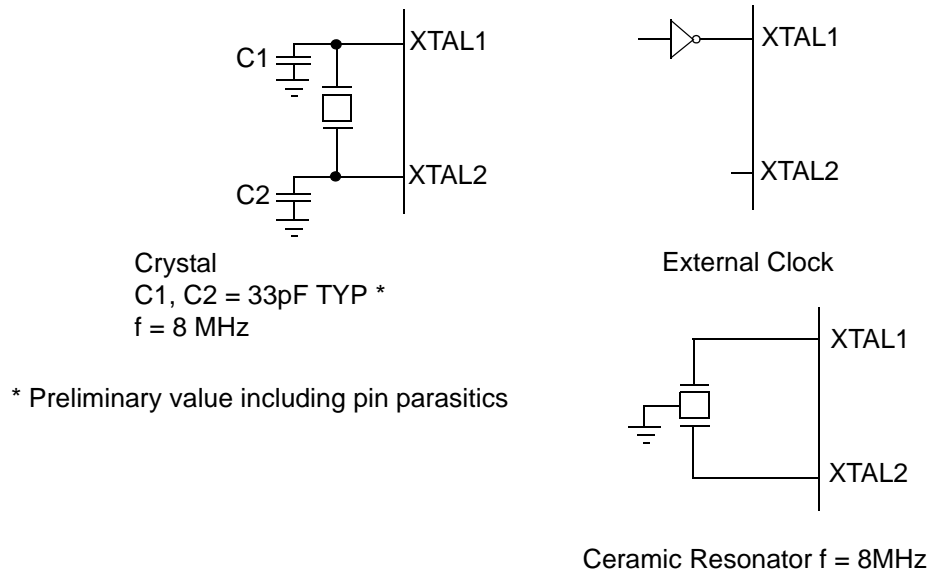


Figure 31. Oscillator Configuration

```
FF      NOP      ; clear the pipeline
6F      Stop     ; enter Stop Mode
```

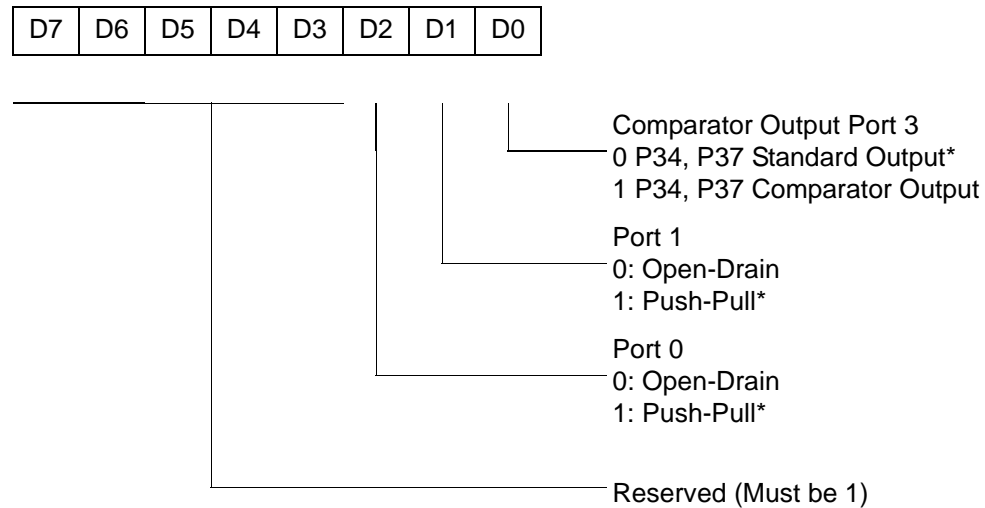
or

```
FF      NOP      ; clear the pipeline
7F      HALT     ; enter HALT Mode
```

Port Configuration Register

The Port Configuration (PCON) register (Figure 32) configures the comparator output on Port 3. It is located in the expanded register 2 at Bank F, location 00.

PCON(FH)00H



* Default setting after reset

Figure 32. Port Configuration Register (PCON) (Write Only)

Comparator Output Port 3 (D0)

Bit 0 controls the comparator used in Port 3. A 1 in this location brings the comparator outputs to P34 and P37, and a 0 releases the Port to its standard I/O configuration.

Port 1 Output Mode (D1)

Bit 1 controls the output mode of port 1. A 1 in this location sets the output to push-pull, and a 0 sets the output to open-drain.

Low-Voltage Detection Register—LVD(D)0Ch

- **Note:** Voltage detection does not work at Stop mode. It must be disabled during Stop mode in order to reduce current.

Field	Bit Position	Description		
LVD	76543---	Reserved No Effect		
	----2--	R	1 0*	HVD flag set HVD flag reset
	-----1-	R	1 0*	LVD flag set LVD flag reset
	-----0	R/W	1 0*	Enable VD Disable VD
*Default after POR				

- **Note:** Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

Voltage Detection and Flags

The Voltage Detection register (LVD, register 0CH at the expanded register bank 0Dh) offers an option of monitoring the V_{CC} voltage. The Voltage Detection is enabled when bit 0 of LVD register is set. Once Voltage Detection is enabled, the V_{CC} level is monitored in real time. The flags in the LVD register valid 20uS after Voltage Detection is enabled. The HVD flag (bit 2 of the LVD register) is set only if V_{CC} is higher than V_{HVD} . The LVD flag (bit 1 of the LVD register) is set only if V_{CC} is lower than the V_{LVD} . When Voltage Detection is enabled, the LVD flag also triggers IRQ5. The IRQ bit 5 latches the low voltage condition until it is cleared by instructions or reset. The IRQ5 interrupt is served if it is enabled in the IMR register. Otherwise, bit 5 of IRQ register is latched as a flag only.

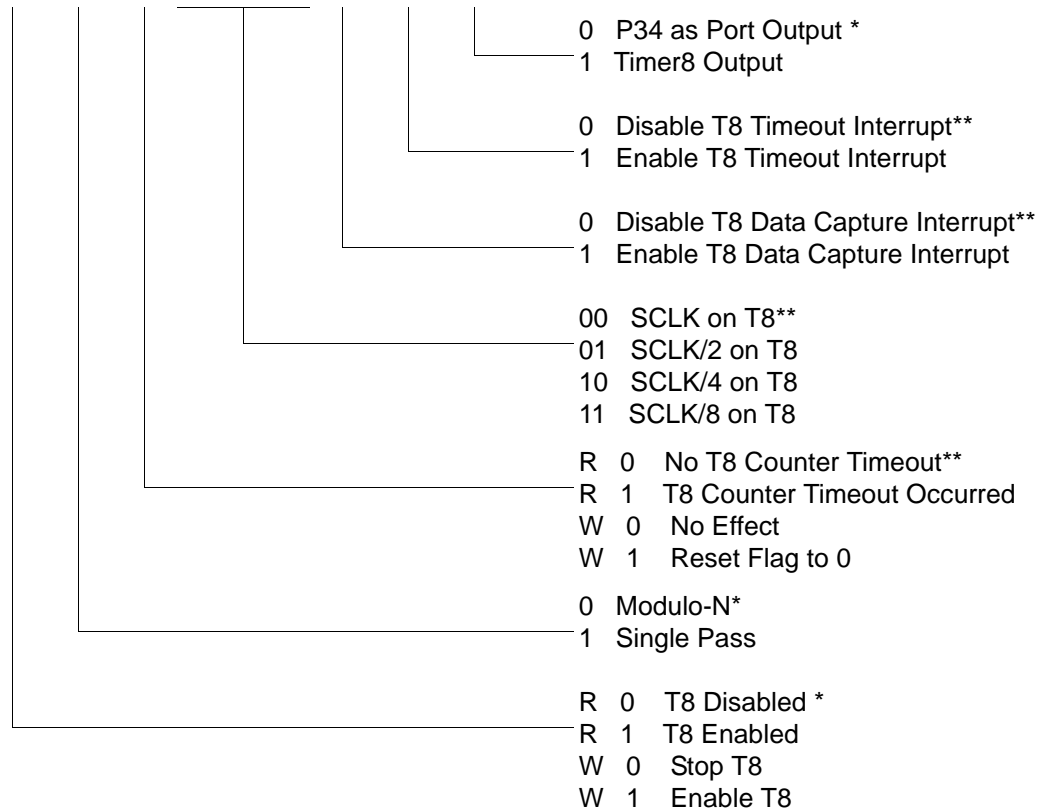
- **Notes:** If it is necessary to receive an LVD interrupt upon power-up at an operating voltage lower than the low battery detect threshold, enable interrupts using the Enable Interrupt instruction (EI) prior to enabling the voltage detection.

Expanded Register File Control Registers (0D)

The expanded register file control registers (0D) are depicted in Figure 39 through Figure 43.

CTR0(0D)00H

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



* Default setting after reset

**Default setting after reset. Not reset with Stop Mode recovery.

Figure 39. TC8 Control Register ((0D)00H: Read/Write Except Where Noted)

CTR1(0D)01H

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

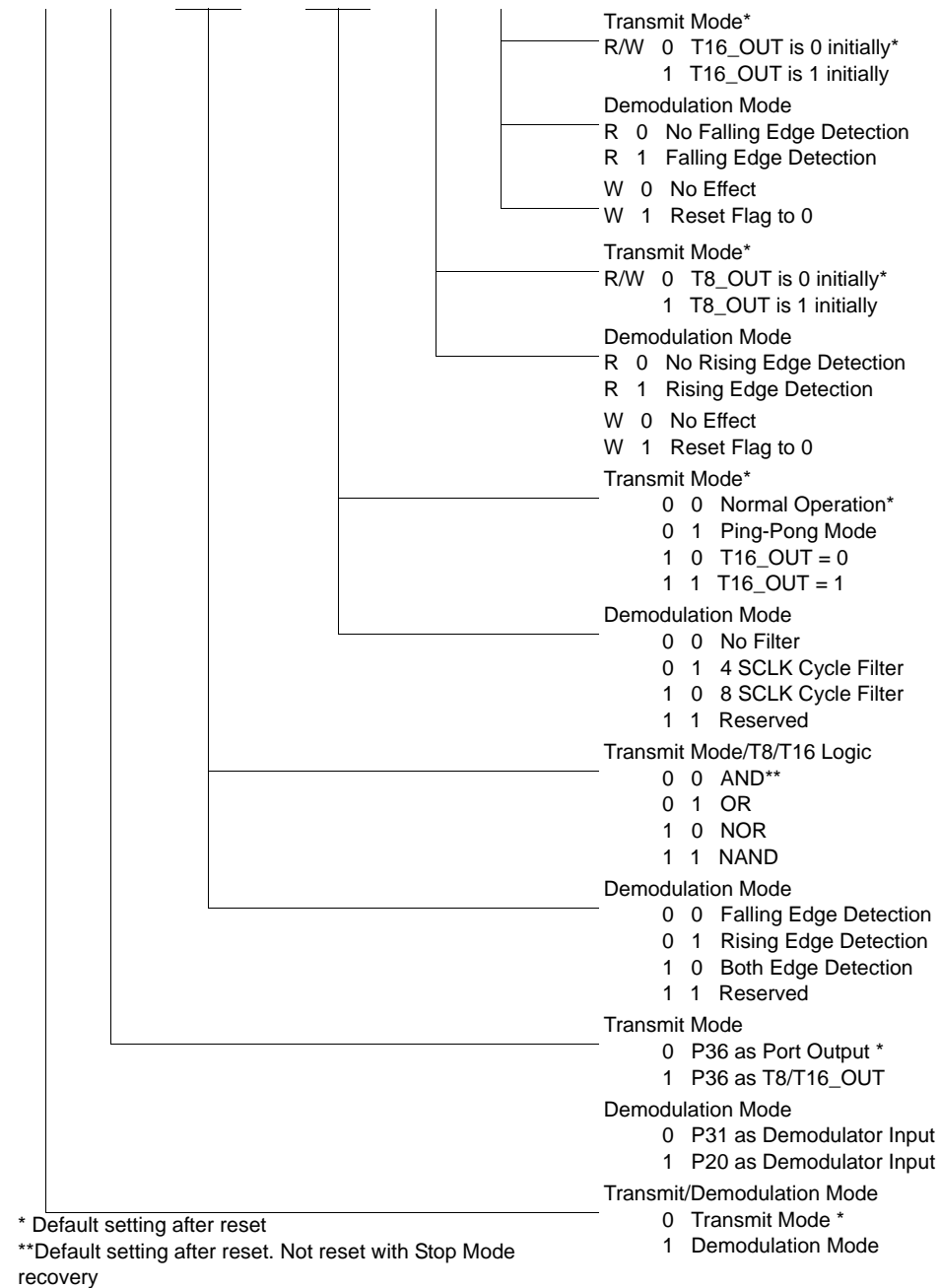


Figure 40. T8 and T16 Common Control Functions ((0D)01H: Read/Write)

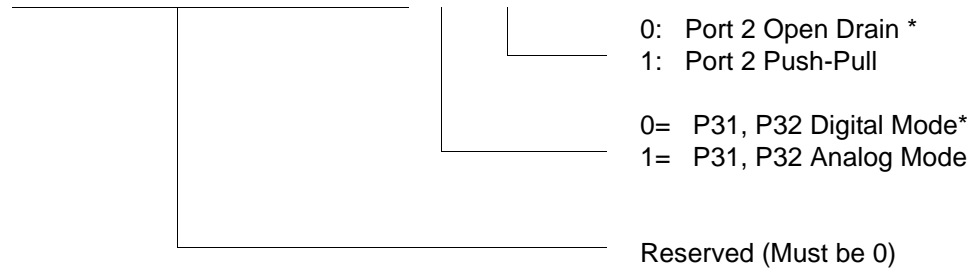


- **Notes:** Take care in differentiating the Transmit Mode from Demodulation Mode. Depending on which of these two modes is operating, the CTR1 bit has different functions.

Changing from one mode to another cannot be performed without disabling the counter/timers.

R247 P3M(F7H)

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



* Default setting after reset. Not reset with Stop Mode recovery.

Figure 49. Port 3 Mode Register (F7H: Write Only)

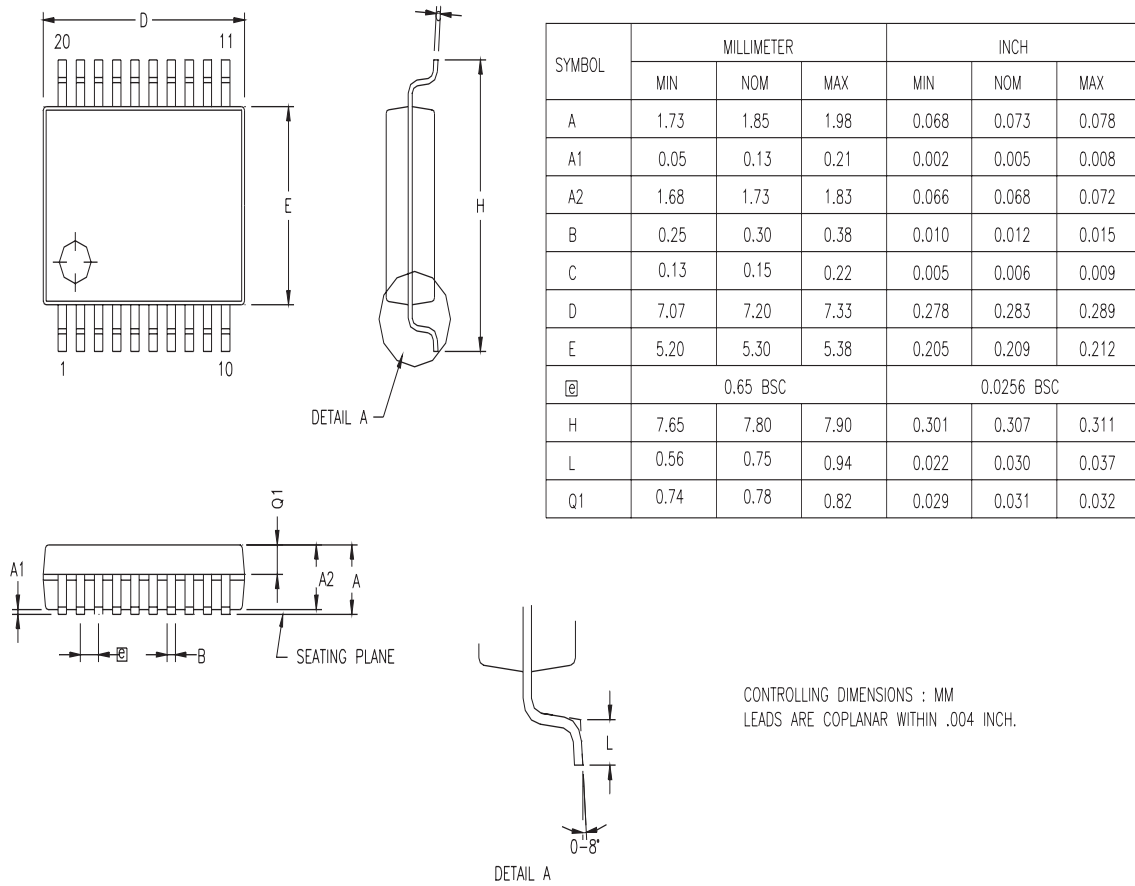


Figure 61. 20-Pin SSOP Package Diagram

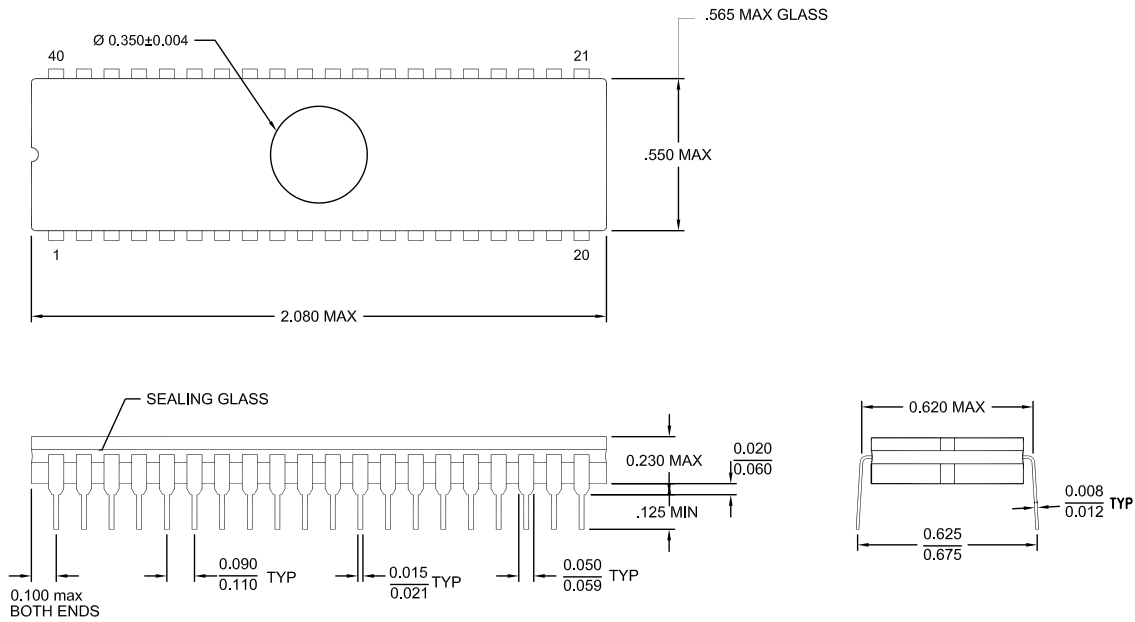
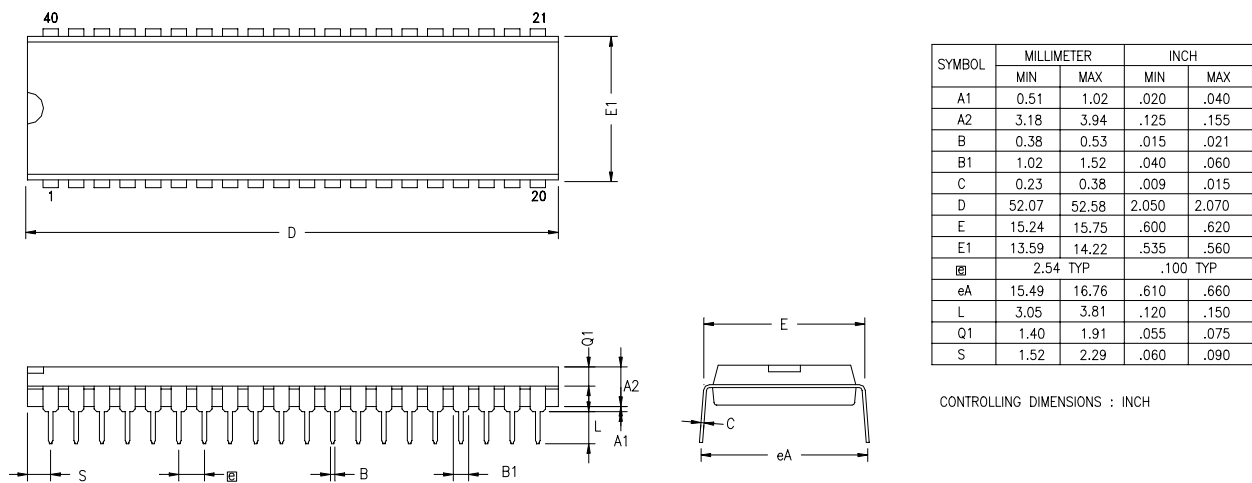


Figure 66. 40-Pin CDIP Package



CONTROLLING DIMENSIONS : INCH

Figure 67. 40-Pin PDIP Package Diagram

Ordering Information

32KB Standard Temperature: 0° to +70°C			
Part Number	Description	Part Number	Description
ZGP323LSH4832C	48-pin SSOP 32K OTP	ZGP323LSS2832C	28-pin SOIC 32K OTP
ZGP323LSP4032C	40-pin PDIP 32K OTP	ZGP323LSH2032C	20-pin SSOP 32K OTP
ZGP323LSH2832C	28-pin SSOP 32K OTP	ZGP323LSP2032C	20-pin PDIP 32K OTP
ZGP323LSP2832C	28-pin PDIP 32K OTP	ZGP323LSS2032C	20-pin SOIC 32K OTP
ZGP323LSK2032E	20-pin CDIP 32K OTP	ZGP323LSK4032E	40-pin CDIP 32K OTP
		ZGP323LSK2832E	28-pin CDIP 32K OTP
32KB Extended Temperature: -40° to +105°C			
Part Number	Description	Part Number	Description
ZGP323LEH4832C	48-pin SSOP 32K OTP	ZGP323LES2832C	28-pin SOIC 32K OTP
ZGP323LEP4032C	40-pin PDIP 32K OTP	ZGP323LEH2032C	20-pin SSOP 32K OTP
ZGP323LEH2832C	28-pin SSOP 32K OTP	ZGP323LEP2032C	20-pin PDIP 32K OTP
ZGP323LEP2832C	28-pin PDIP 32K OTP	ZGP323LES2032C	20-pin SOIC 32K OTP
32KB Automotive Temperature: -40° to +125°C			
Part Number	Description	Part Number	Description
ZGP323LAH4832C	48-pin SSOP 32K OTP	ZGP323LAS2832C	28-pin SOIC 32K OTP
ZGP323LAP4032C	40-pin PDIP 32K OTP	ZGP323LAH2032C	20-pin SSOP 32K OTP
ZGP323LAH2832C	28-pin SSOP 32K OTP	ZGP323LAP2032C	20-pin PDIP 32K OTP
ZGP323LAP2832C	28-pin PDIP 32K OTP	ZGP323LAS2032C	20-pin SOIC 32K OTP
Note: Replace C with G for Lead-Free Packaging			